Patent Case No.: 58028US006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

First Named Inventor: KAWATE, KOHICHIRO

Application No.: 10/517670 Confirmation No.: 1922

Filed: June 23, 2003

Title: HEAT CURABLE ADHESIVE COMPOSITION, ARTICLE, SEMICONDUCTOR

APPARATUS AND METHOD

RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT (37 CFR § 1.121)

	CERTIFICATE OF MAIL	LING OR TRANSMISSION [3/ CFR § 1.8(2)]
	I hereby certify that this correspondence is being:	
Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450	□ transmitted to United States via the Office electronic filin September 19, 2007	1/41 11/1.
	Date	Signed by: Kathleen M. Sandvig

This is in response to the Notice of Non-Compliant Amendment (37 CFR § 1.121), dated September 10, 2007, in the above-identified application.

The Amendment filed on August 30, 2007, was said to be non-compliant because in the Amendments to the Specification, the amended paragraph(s) do not include markings. In accordance with the instructions in the Notice, a new Amendments to the Specification is submitted.

Fees

- Any required fee will be made at the time of submission via EFS-Web. In the event fees are not or cannot be paid at the time of EFS-Web submission, please charge any fees under 37 CFR § 1.17 which may be required to Deposit Account No. 13-3723.

 Please charge any fees under 37 CFR § 8, 1.16 and 1.17 which may be required to Deposit
- Please charge any fees under 37 CFR §§ 1.16 and 1.17 which may be required to Deposi Account No. 13-3723. (One copy of this sheet marked duplicate is enclosed.)
- Please charge any additional fees associated with the prosecution of this application to Deposit Account No. 13-3723. This authorization includes the fee for any necessary extension of time under 37 CFR § 1.136(a). To the extent any such extension should become necessary, it is hereby requested.
- Please credit any overpayment to the same deposit account.